



## ADDITIONAL INFORMATION PRESS RELEASE

### Quote Dr. Thomas Reisinger, Chief Operations Officer Infineon Technologies Austria

"Infineon is the first company in the world to bring ultra-thin silicon power semiconductors with 20 micrometres to market maturity. Halving the wafer thickness from the industry-standard 40 to 60 micrometres to 20 micrometres is a technical masterpiece - we are pushing the boundaries of what is technically feasible. With the ultra-thin silicon wafers, we are reducing the power loss in power supply systems by more than 15 per cent. This decisive step towards energy efficiency, especially in times of increasing energy demand from AI data centres, underlines the importance of Villach as a competence centre for power semiconductors within the Infineon Group."

[www.infineon.com/austria](http://www.infineon.com/austria)